Dual-Channel, Audio Difference Amplifier

AD8273

FEATURES

- Two gain settings
  - Gain of ½ (−6 dB)
  - Gain of 2 (+6 dB)
  - 0.05% maximum gain error
  - 10 ppm maximum gain drift
- Excellent ac specifications
  - 20 V/µs minimum slew rate
  - 800 ns to 0.01% settling time
- Low distortion: 0.004%, 20 Hz to 20 kHz
- High accuracy dc performance
  - 77 dB minimum CMRR
  - 700 µV maximum offset voltage
- 14-lead SOIC package
- Supply current: 2.5 mA maximum per channel
- Supply range: ±2.5 V to ±18 V

APPLICATIONS

- High performance audio
- Instrumentation amplifier building blocks
- Level translators
- Automatic test equipment
- Sin/Cos encoders

FUNCTIONAL BLOCK DIAGRAM

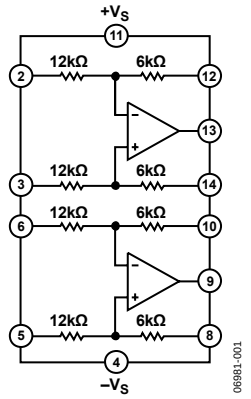

Figure 1.

GENERAL DESCRIPTION

The AD8273 is a low distortion, dual-channel amplifier with internal gain setting resistors. With no external components, it can be configured as a high performance difference amplifier (G = ½ or 2), inverting amplifier (G = ½ or 2), or noninverting amplifier (G = 1½ or 3).

The AD8273 operates on both single and dual supplies and only requires 2.5 mA maximum supply current for each amplifier. It is specified over the industrial temperature range of −40°C to +85°C and is fully RoHS compliant.

Table 1. Difference Amplifiers by Category

Low Distortion	High Voltage	Single-Supply Unidirectional	Single-Supply Bidirectional
AD8270	AD628	AD8202	AD8205
AD8273	AD629	AD8203	AD8206
AMP03			AD8216

Rev. 0

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REVISION HISTORY

1/08—Revision 0: Initial Version

SPECIFICATIONS

V_S = ±15 V, V_{REF} = 0 V, T_A = 25°C, G = ½, R_L = 2 kΩ, unless otherwise noted.

Table 2.

Parameter	Conditions	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
Bandwidth			20		MHz
Slew Rate		20			V/µs
Settling Time to 0.1%	10 V step on output, C_L = 100 pF		670	750	ns
Settling Time to 0.01%	10 V step on output, C_L = 100 pF		750	800	ns
Channel Separation	f = 1 kHz		130		dB
NOISE/DISTORTION[1]					
THD + Noise	f = 1 kHz, V_{OUT} = 10 V p-p, 600 Ω load		0.004		%
Noise Floor, RTO[2]	20 kHz BW		−106		dBu
Output Voltage Noise (Referred to Output)	f = 20 Hz to 20 kHz		3.5		µV rms
	f = 1 kHz		26		nV/√Hz
GAIN					
Gain Error				0.05	%
Gain Drift	−40°C to +85°C		2	10	ppm/°C
Gain Nonlinearity	V_{OUT} = 10 V p-p, 600 Ω load		200		ppm
	V_{OUT} = 5 V p-p, 600 Ω load		50		ppm
INPUT CHARACTERISTICS					
Offset[3]	Referred to output		100	700	µV
vs. Temperature	−40°C to +85°C		3		µV/°C
vs. Power Supply	V_S = ±2.5 V to ±18 V		2	10	µV/V
Common-Mode Rejection Ratio	V_{CM} = ±40 V, R_S = 0 Ω, referred to input	77	86		dB
Input Voltage Range[4]		$-3V_S + 4.5$		$+3V_S - 4.5$	V
Impedance[5]					
Differential	V_{CM} = 0 V		36		kΩ
Common Mode[6]			9		kΩ
OUTPUT CHARACTERISTICS					
Output Swing		$-V_S + 1.5$		$+V_S - 1.5$	V
Short-Circuit Current Limit	Sourcing		100		mA
	Sinking		60		mA
Capacitive Load Drive	G = ½		200		pF
	G = 2		1200		pF
POWER SUPPLY					
Supply Current (per Amplifier)				2.5	mA
TEMPERATURE RANGE					
Specified Performance		−40		+85	°C

[1] Includes amplifier voltage and current noise, as well as noise of internal resistors.
[2] dBu = 20 log (V rms /0.7746).
[3] Includes input bias and offset current errors.
[4] May also be limited by absolute maximum input voltage or by the output swing. See the Absolute Maximum Ratings section and Figure 9 through Figure 12 for details.
[5] Internal resistors are trimmed to be ratio matched but have ±20% absolute accuracy.
[6] Common mode is calculated looking into both inputs. Common-mode impedance looking into only one input is 18 kΩ.

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	±18 V
Output Short-Circuit Current	Observe derating curve
Voltage at Any Input Pin	40 V
Differential Input Voltage	40 V
Current into Any Input Pin	3 mA
Storage Temperature Range	−65°C to +130°C
Specified Temperature Range	−40°C to +85°C
Thermal Resistance	
θ_{JA}	105°C/W
θ_{JC}	36°C/W
Package Glass Transition Temperature (T_G)	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

MAXIMUM POWER DISSIPATION

The maximum safe power dissipation for the AD8273 is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the amplifiers. Exceeding a temperature of 150°C for an extended period can result in a loss of functionality.

The AD8273 has built-in, short-circuit protection that limits the output current to approximately 100 mA (see Figure 2 for more information). While the short-circuit condition itself does not damage the part, the heat generated by the condition can cause the part to exceed its maximum junction temperature, with corresponding negative effects on reliability.

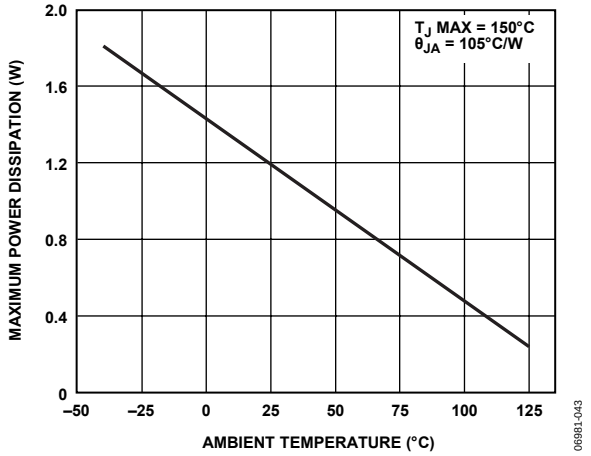


Figure 2. Maximum Power Dissipation vs. Ambient Temperature

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

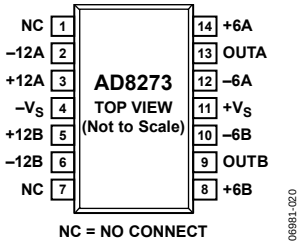


Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1, 7	NC	No Connect.
2	−12A	The 12 kΩ resistor connects to the negative terminal of Op Amp A.
3	+12A	The 12 kΩ resistor connects to the positive terminal of Op Amp A.
4	$-V_S$	Negative Supply.
5	+12B	The 12 kΩ resistor connects to the positive terminal of Op Amp B.
6	−12B	The 12 kΩ resistor connects to the negative terminal of Op Amp B.
8	+6B	The 6 kΩ resistor connects to the positive terminal of Op Amp B.
9	OUTB	Op Amp B Output.
10	−6B	The 6 kΩ resistor connects to the negative terminal of Op Amp B.
11	$+V_S$	Positive Supply.
12	−6A	The 6 kΩ resistor connects to the negative terminal of Op Amp A.
13	OUTA	Op Amp A Output.
14	+6A	The 6 kΩ resistor connects to the positive terminal of Op Amp A.

TYPICAL PERFORMANCE CHARACTERISTICS

V_S = ±15 V, T_A = 25°C, G = ½, difference amplifier configuration, unless otherwise noted.

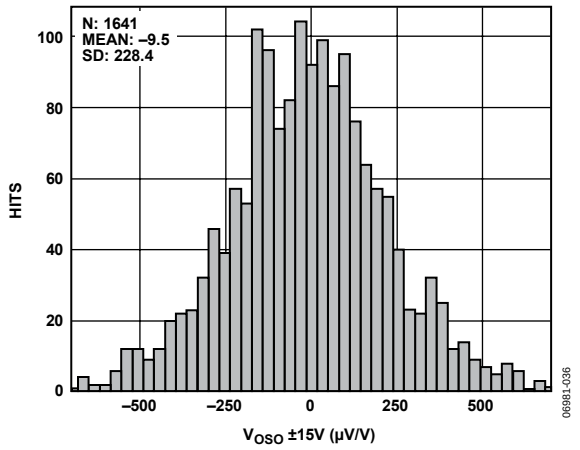


Figure 4. Typical Distribution of System Offset Voltage, G = ½, Referred to Output

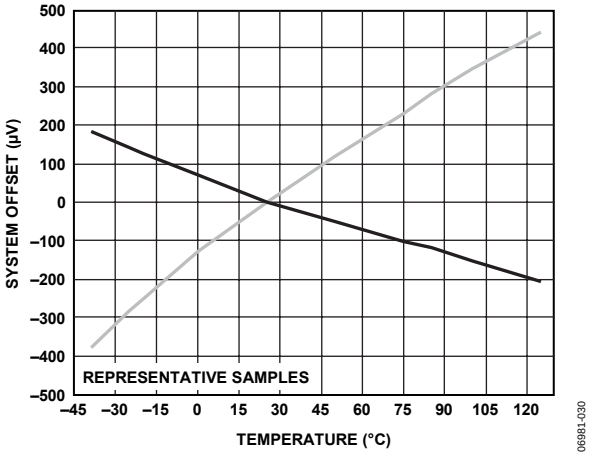


Figure 7. System Offset vs. Temperature, Normalized at 25°C, Referred to Output

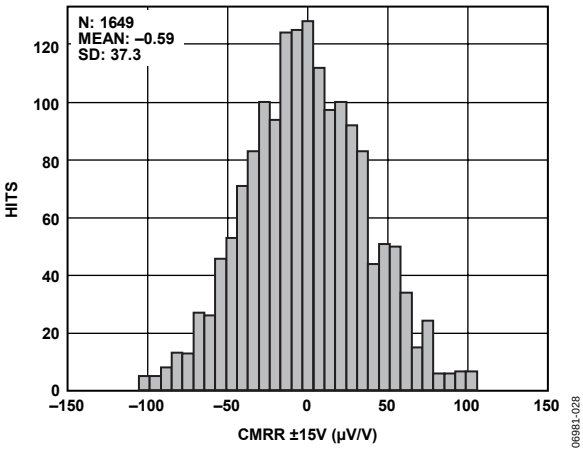


Figure 5. Typical Distribution of CMRR, G = ½, Referred to Input

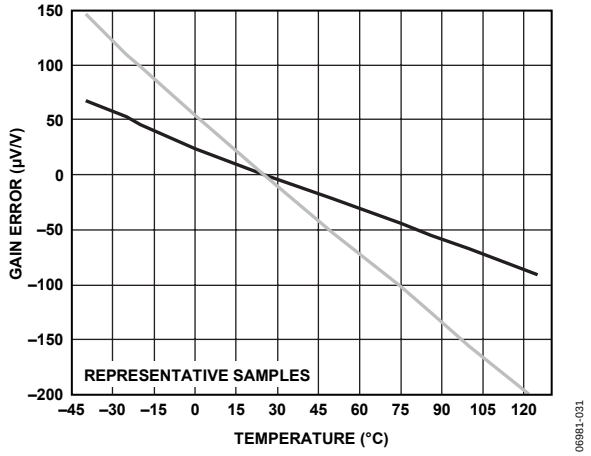


Figure 8. Gain Error vs. Temperature, Normalized at 25°C

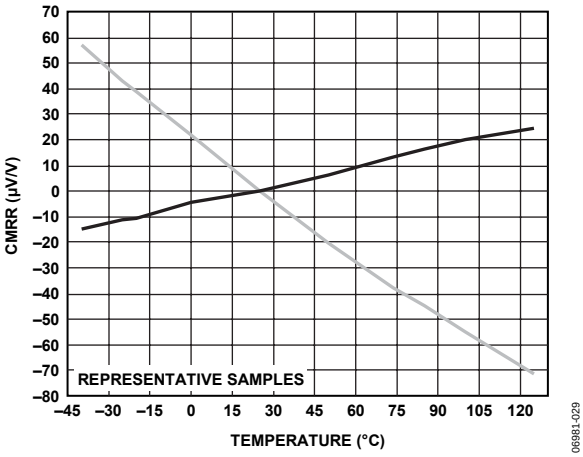


Figure 6. CMRR vs. Temperature, Normalized at 25°C

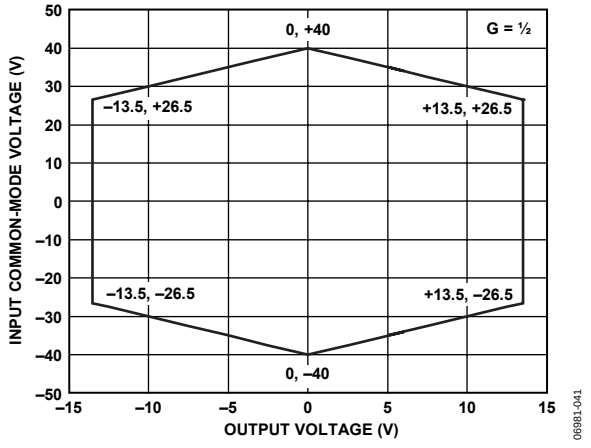


Figure 9. Input Common-Mode Voltage vs. Output Voltage, Gain = ½, ±15 V Supplies

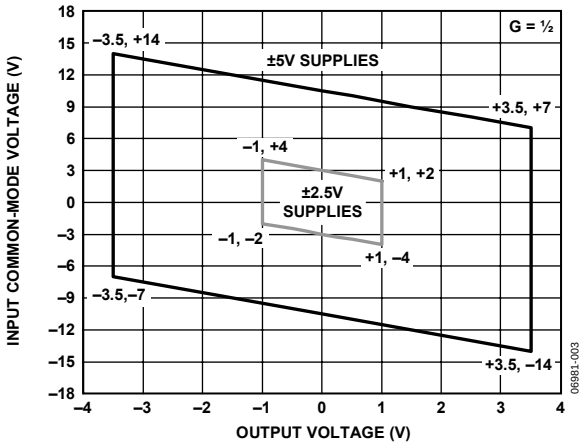


Figure 10. Input Common-Mode Voltage vs. Output Voltage, Gain = ½, ±5 V and ±2.5 V Supplies

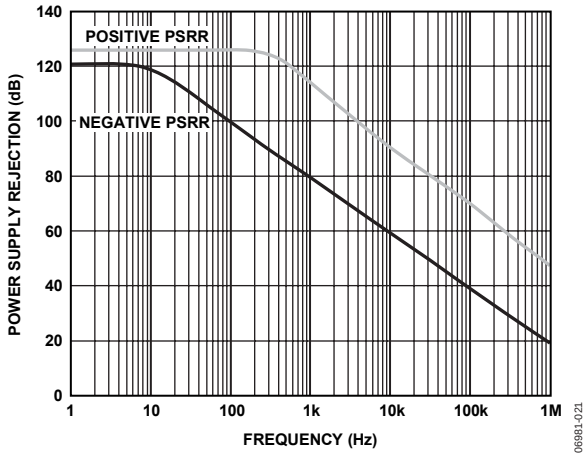


Figure 13. Power Supply Rejection vs. Frequency, G = ½, Referred to Output

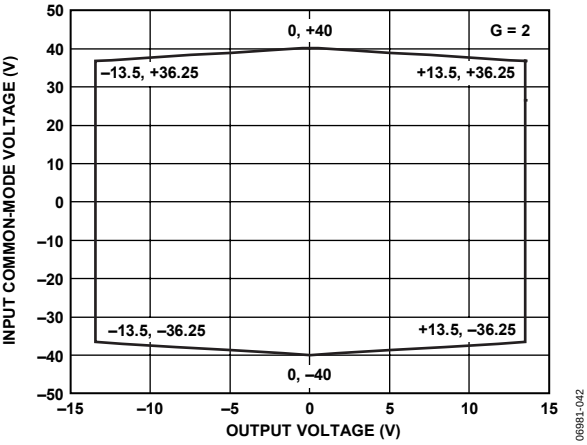


Figure 11. Input Common-Mode Voltage vs. Output Voltage, Gain = 2, ±15 V Supplies

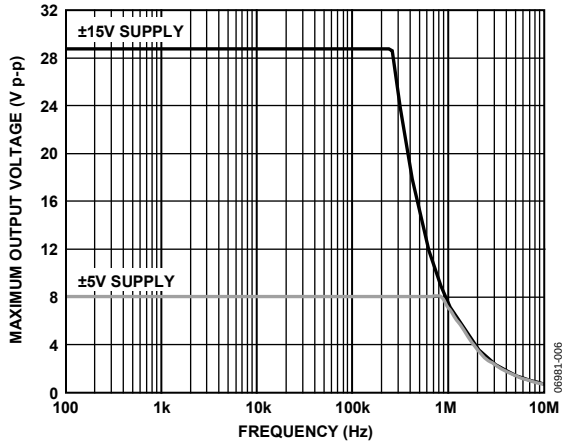


Figure 14. Maximum Output Voltage vs. Frequency

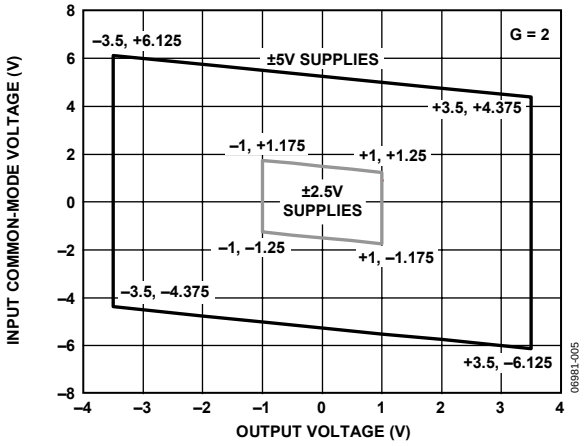


Figure 12. Input Common-Mode Voltage vs. Output Voltage, Gain = 2, ±5 V and ±2.5 V Supplies

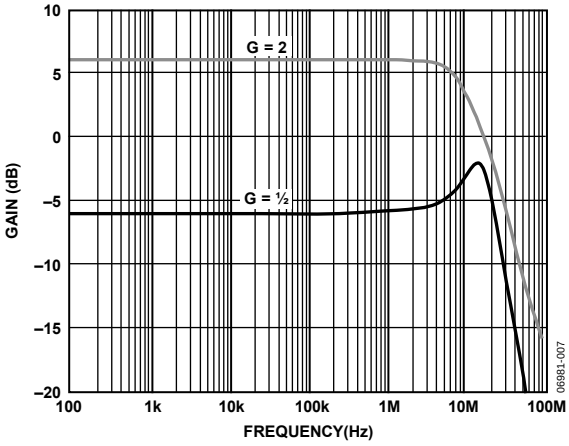


Figure 15. Gain vs. Frequency

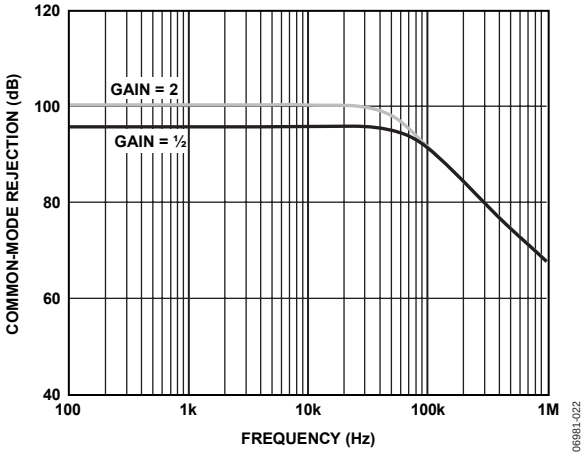


Figure 16. Common-Mode Rejection vs. Frequency, Referred to Input

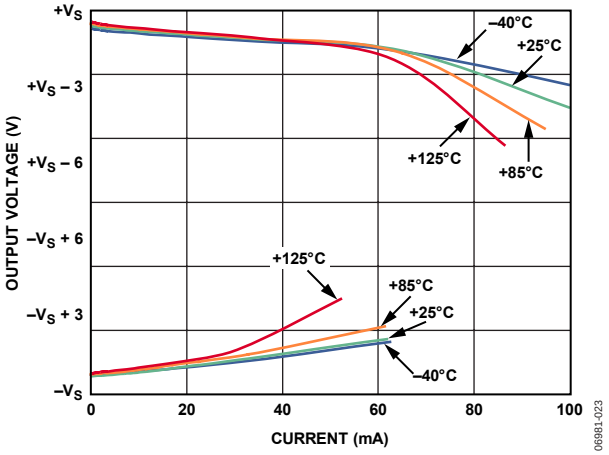


Figure 19. Output Voltage vs. I_{OUT}

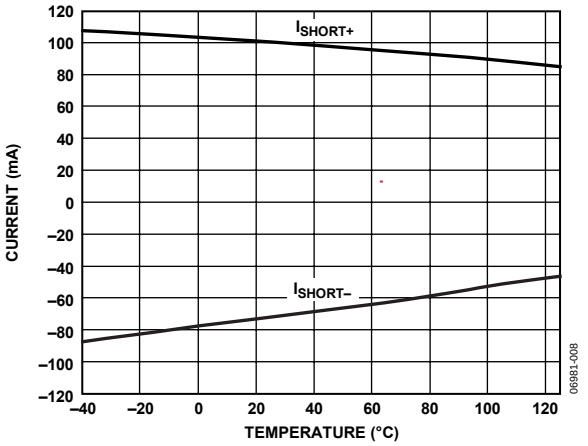


Figure 17. Short-Circuit Current vs. Temperature

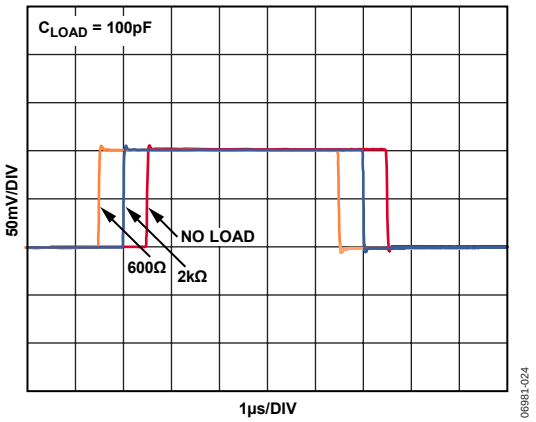


Figure 20. Small Signal Step Response, Gain = 2

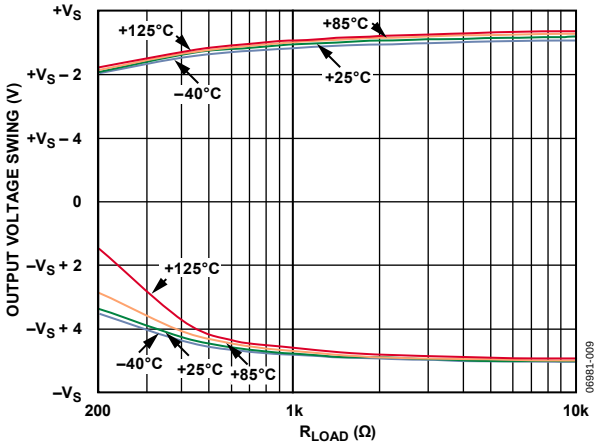


Figure 18. Output Voltage Swing vs. R_{LOAD}, $V_S = \pm 15$ V

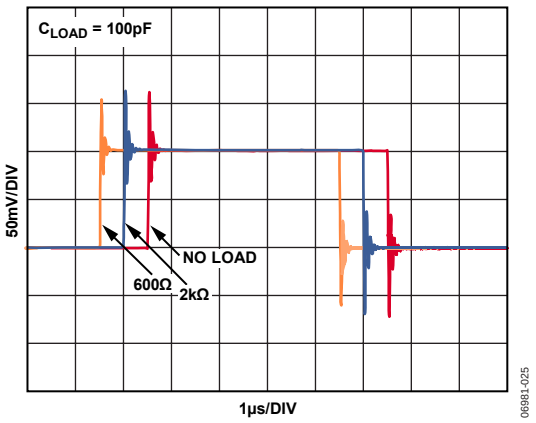


Figure 21. Small Signal Step Response, Gain = ½

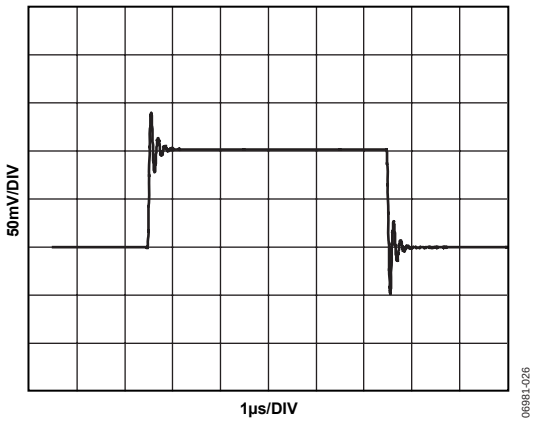


Figure 22. Small Signal Pulse Response with 500 pF Capacitor Load, Gain = 2

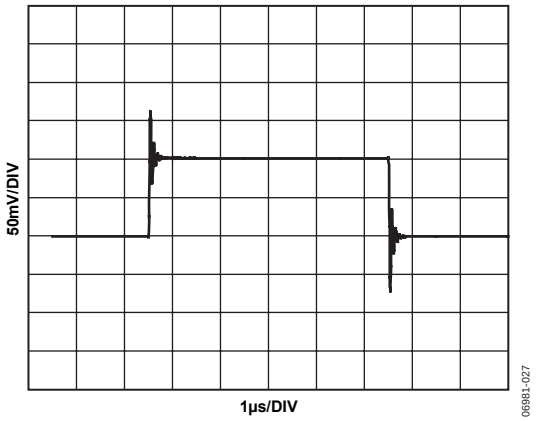


Figure 23. Small Signal Pulse Response for 100 pF Capacitive Load, Gain = ½

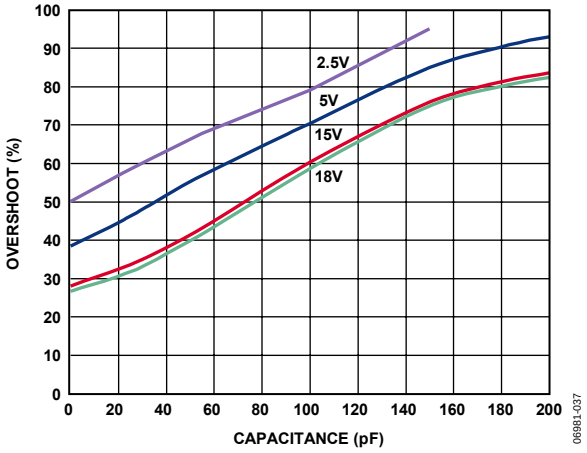


Figure 24. Small Signal Overshoot vs. Capacitive Load, G = ½, No Resistive Load

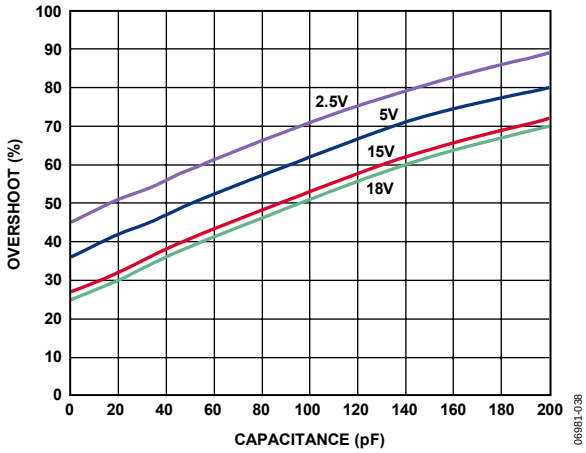


Figure 25. Small Signal Overshoot vs. Capacitive Load, G = ½, 600 Ω in Parallel with Capacitive Load

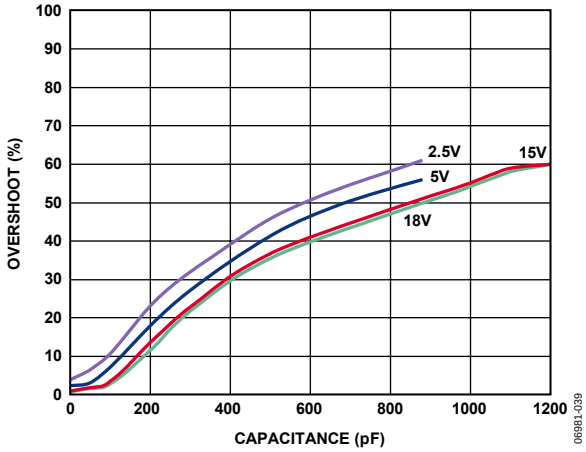


Figure 26. Small Signal Overshoot vs. Capacitive Load, G = 2, No Resistive Load

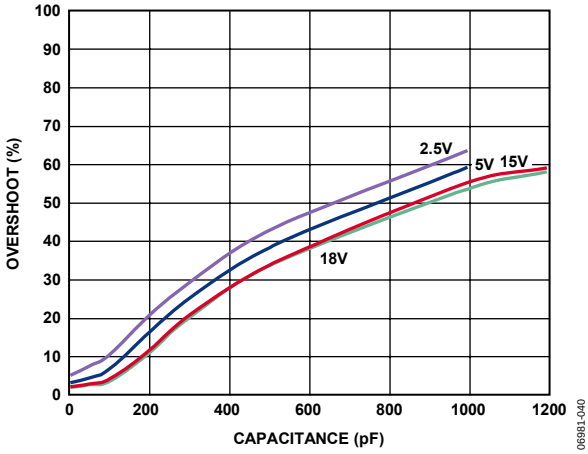


Figure 27. Small Signal Overshoot vs. Capacitive Load, G = 2, 600 Ω in Parallel with Capacitive Load

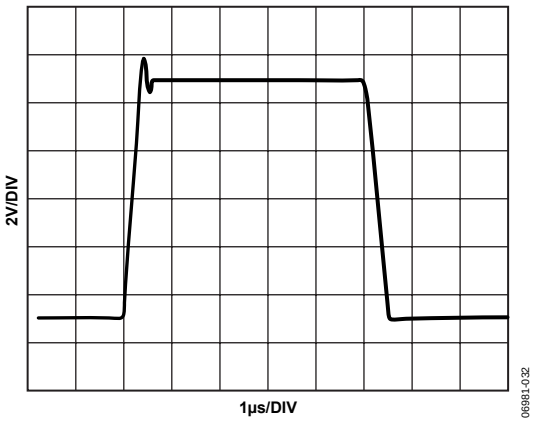


Figure 28. Large Signal Pulse Response Gain = ½

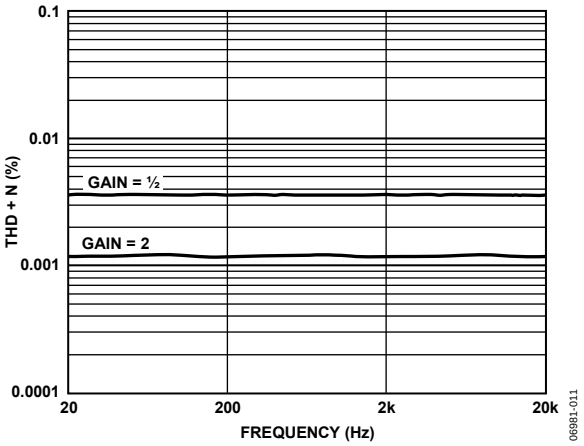


Figure 31. THD+N vs. Frequency, V_{OUT} = 10 V p-p

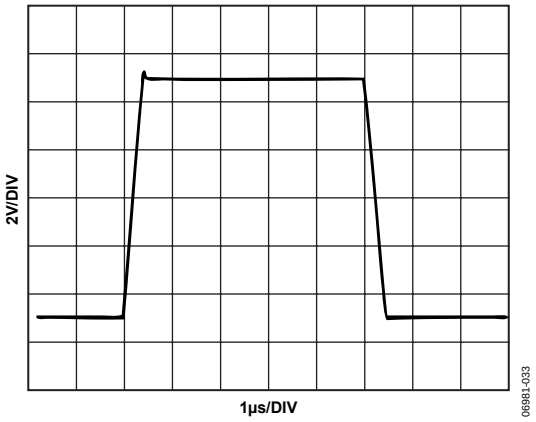


Figure 29. Large Signal Pulse Response, Gain = 2

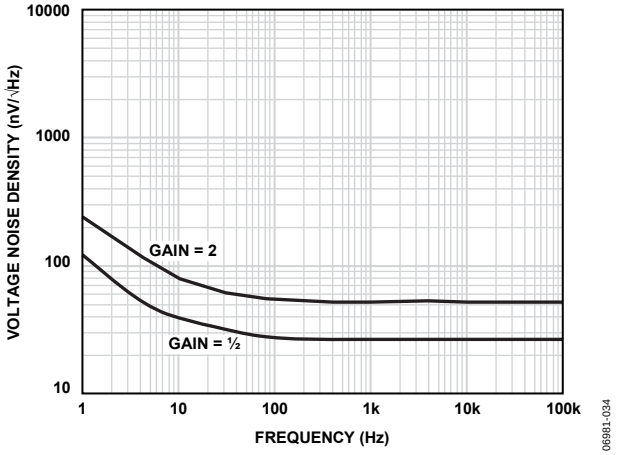


Figure 32. Voltage Noise Density vs. Frequency, Referred to Output

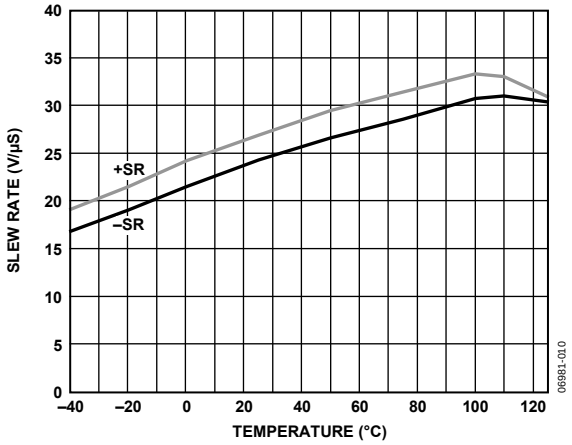


Figure 30.Slew Rate vs. Temperature

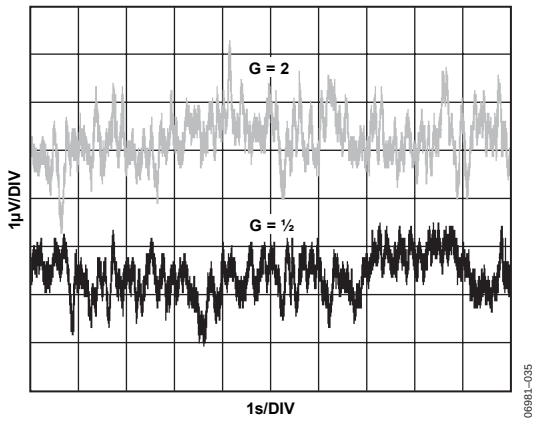


Figure 33. 0.1 Hz to 10 Hz Voltage Noise, RTO

THEORY OF OPERATION

The AD8273 has two channels, each consisting of a high precision, low distortion op amp and four trimmed resistors. Although such a circuit can be built discretely, placing the resistors on the chip offers advantages to board designers that include better dc specifications, better ac specification, and lower production costs.

The resistors on the AD8273 are laser trimmed and tightly matched. Specifications that depend on the resistor matching, such as gain drift, common-mode rejection, and gain accuracy, are better than can be achieved with standard discrete resistors.

The positive and negative input terminals of the AD8273 op amp are not pinned out intentionally. Keeping these nodes internal means their capacitance is considerably lower than it would be in discrete designs. Lower capacitance at these nodes means better loop stability and improved common-mode rejection vs. frequency.

The internal resistors of the AD8273 lower production cost. One part rather than several is placed on the board, which improves both board build time and reliability.

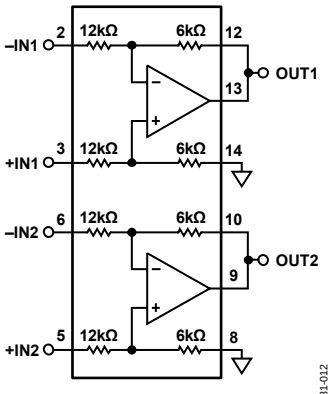
CONFIGURATIONS

The AD8273 can be configured in several different ways; see Figure 34 to Figure 41. Because these configurations rely on the internal, matched resistors, these configurations have excellent gain accuracy and gain drift.

POWER SUPPLIES

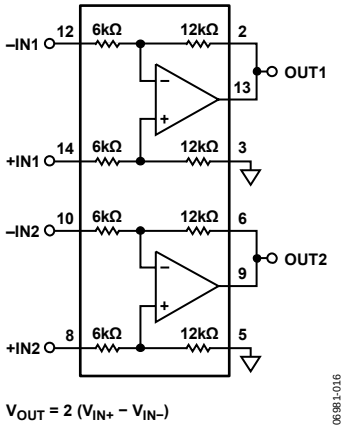
A stable dc voltage should be used to power the AD8273. Noise on the supply pins can adversely affect performance. A bypass capacitor of 0.1 µF should be placed between each supply pin and ground, as close to each pin as possible. A tantalum capacitor of 10 µF should also be used between each supply and ground. It can be farther away from the AD8273 and typically can be shared by other precision integrated circuits.

The AD8273 is specified at ±15 V, but it can be used with unbalanced supplies as well, for example, $-V_S$ = 0 V, $+V_S$ = 20 V. The difference between the two supplies must be kept below 36 V.



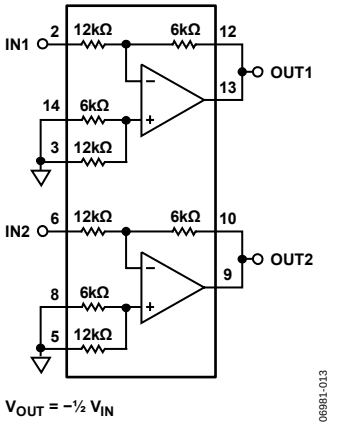
$V_{OUT} = ½ (V_{IN+} - V_{IN-})$

Figure 34. Difference Amplifier, G = ½



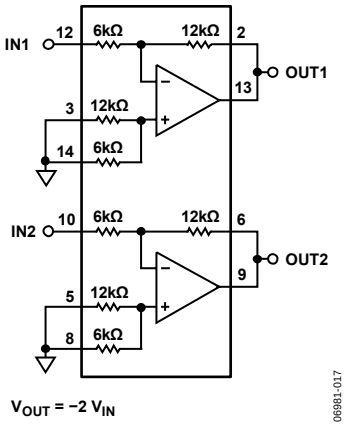
$V_{OUT} = 2 (V_{IN+} - V_{IN-})$

Figure 35. Difference Amplifier, G = 2



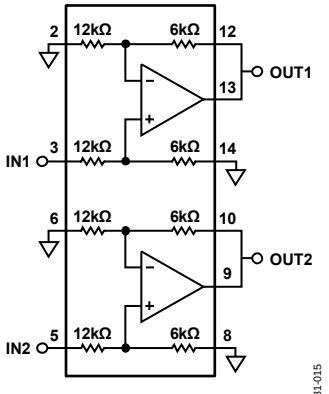
$V_{OUT} = -½ V_{IN}$

Figure 36. Inverting Amplifier, G = ½



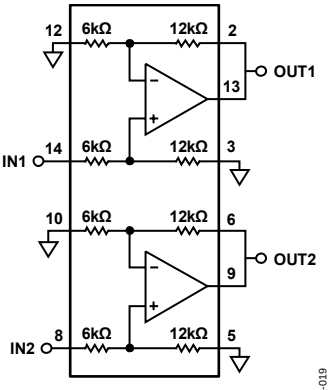
$V_{OUT} = -2 V_{IN}$

Figure 37. Inverting Amplifier, G = 2



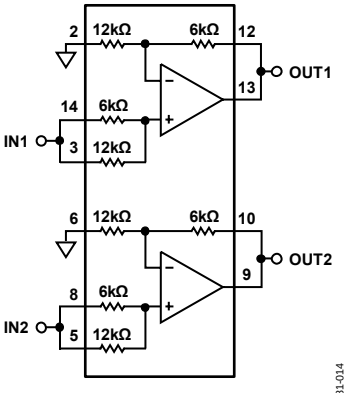
V_{OUT} = ½ V_{IN}

Figure 38. Noninverting Amplifier, G = ½



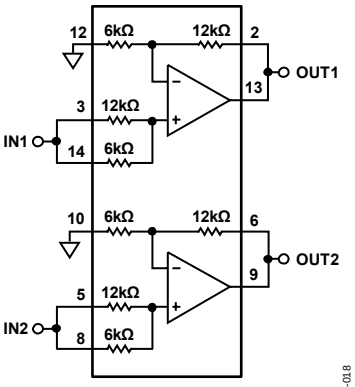
V_{OUT} = 2 V_{IN}

Figure 39. Noninverting Amplifier, G = 2



V_{OUT} = 1½ V_{IN}

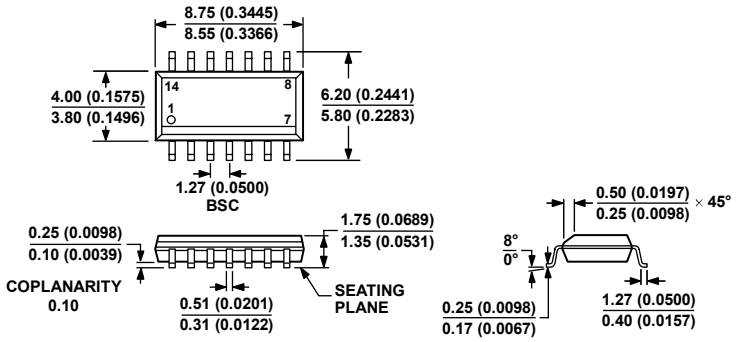
Figure 40. Noninverting Amplifier, G = 1.5



V_{OUT} = 3 V_{IN}

Figure 41. Noninverting Amplifier, G = 3

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AB
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

060606-A

Figure 42. 14-Lead Standard Small Outline Package [SOIC_N]
Narrow Body (R-14)
Dimensions shown in millimeters and (inches)

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD8273ARZ[1]	−40°C to +85°C	14-Lead SOIC_N	R-14
AD8273ARZ-R7[1]	−40°C to +85°C	14-Lead SOIC_N, 7" Tape and Reel	R-14
AD8273ARZ-RL[1]	−40°C to +85°C	14-Lead SOIC_N, 13" Tape and Reel	R-14

[1] Z = RoHS Compliant Part.

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